

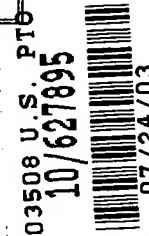


PATENT APPLICATION
Docket No. 9898-278
Client No. SS-17653-US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

EXPRESS MAIL	MAILING LABEL NO. <u>EV321250775US</u>
	DATE OF DEPOSIT: <u>JULY 24, 2003</u>
I HEREBY CERTIFY THAT THIS PAPER AND ENCLOSURES AND/OR FEE ARE BEING DEPOSITED WITH THE UNITED STATES POSTAL SERVICE "EXPRESS MAIL POST OFFICE TO ADDRESSEE" SERVICE UNDER 37 CFR 1.10 ON THE DATE INDICATED ABOVE AND IS ADDRESSED TO: MAIL STOP PATENT APPLICATION, COMMISSIONER FOR PATENTS, P.O. BOX 1450, ALEXANDRIA, VA 22313-1450.	
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Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450



Enclosed for filing is a patent application under 37 CFR 1.53(b) of:

Inventor: Je-Min Park

For: METHOD FOR FABRICATING SEMICONDUCTOR DEVICE
BY FORMING DAMASCENE INTERCONNECTIONS

Applicant requests FIG. 8A to be published with the application.

Enclosures:

- ☒ Specification (pages 1-11); claims (pages 12-15); abstract (page 16)
- ☒ EIGHTEEN sheet(s) of FORMAL drawings (comprising 24 figures)
- ☒ Certified copy of Priority Document No. 2002-47588, filed August 12, 2002
- ☒ Return Postcard

CLAIMS AS FILED				
For	Number Filed	Number Extra	Rate	Basic Fee \$750
Total Claims	17-20	0	x \$ 18 =	\$0.00
Independent Claims	2-3	0	x \$ 84 =	\$0.00
TOTAL FILING FEE				\$750.00

☒ Combined Declaration and Power of Attorney

☒ Newly executed (original or copy)

☐ Assignment with cover sheet

Assignee Name and Address:

Samsung Electronics Co., Ltd.

Suwon-city, Kyungki-do

Republic of Korea

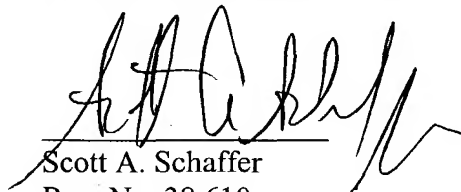
☒ PTO Form 2038 authorizing credit card payment of \$750.00 (filing fee) is enclosed.

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Respectfully submitted,

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